ˊ ˍ ˚ Ł ₰ ᵍ Ϙ ㄩ ‖ ㄱ ı ɾ ᵇ ɔ ᴙ χ 433Y ı* ᵇ ɔ ㄩ χ 513D ı ᑫ ȝ SMAF Ṃ Ł

Surface Mount Schottky Barrier Rectifier, Reverse Voltage˙ 100V, Forward Current:2.0A ,SMAF thin package.

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Low power loss, high efficiency, High forward surge current capability, For use in low voltage, high frequency inverters, and polarity protection applications,For surface mounted applications,HF Product.

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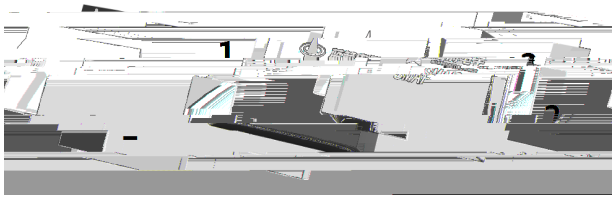
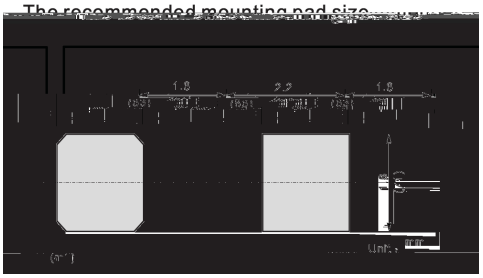
General purpose.

##



PIN	DESCRIPTION
1	Cathode
2	Anode



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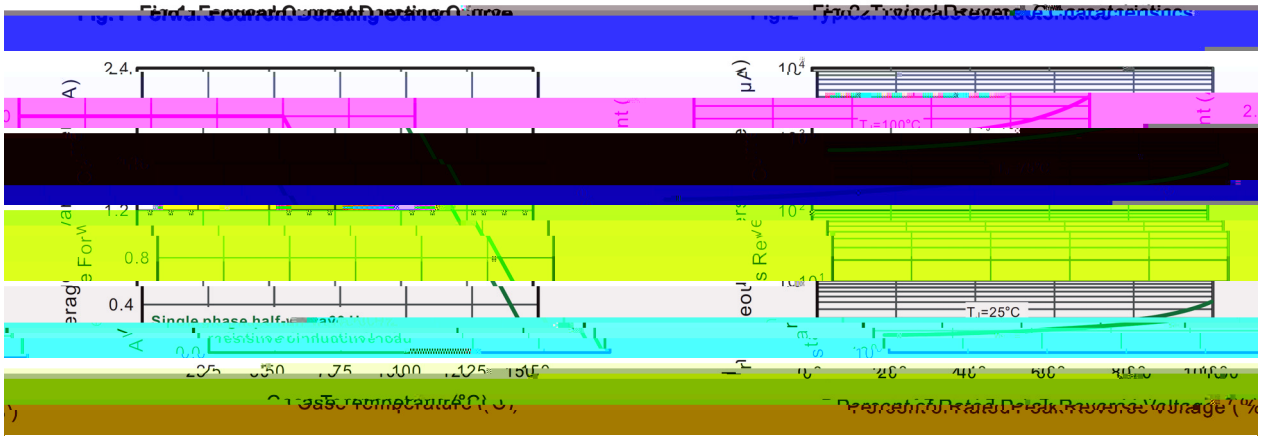
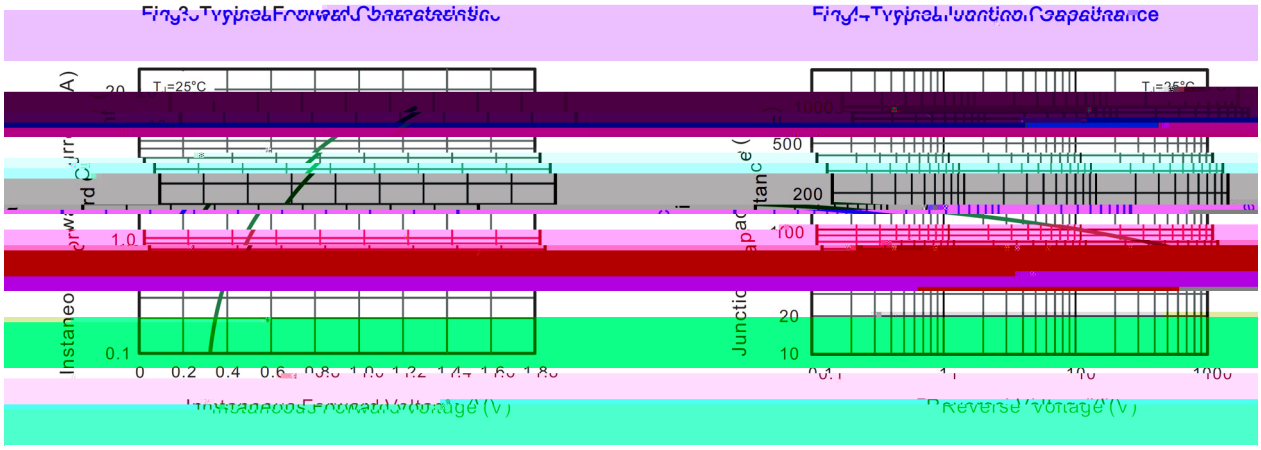
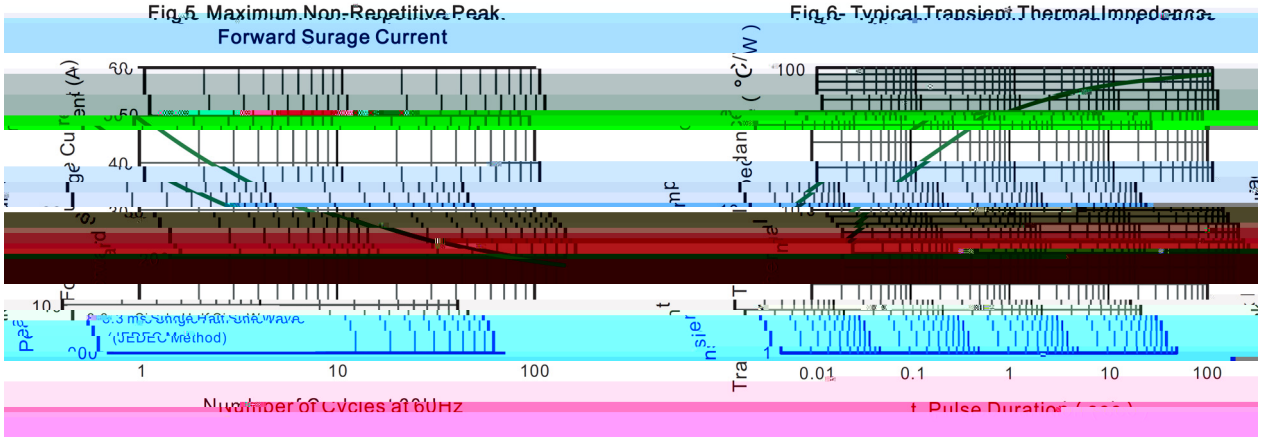
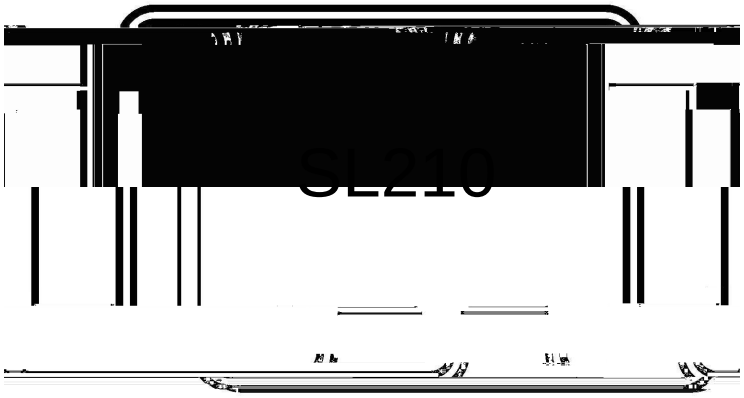
See Marking Instructions.

v ¨Ω Parameter	ϒ N Symbol	¨Ω Ö Rating	D Ч Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Maximum RMS voltage	V_{RMS}	70	V


Single phase half-wave
resistive or inductive load
0.4
0.8
1.2
2.4
T=25°C


T=25°C
1.0
0.1
0
0.2
0.4
0.6
20
500
200
100
10


8.3 ms Single Half-sine-wave
(JEDEC Method)
1
10
100
0.01
0.1
1
10
100



ᄂ ˝ χ

V0543 χ ᄒᄌ ᄀ ᄀᄇ

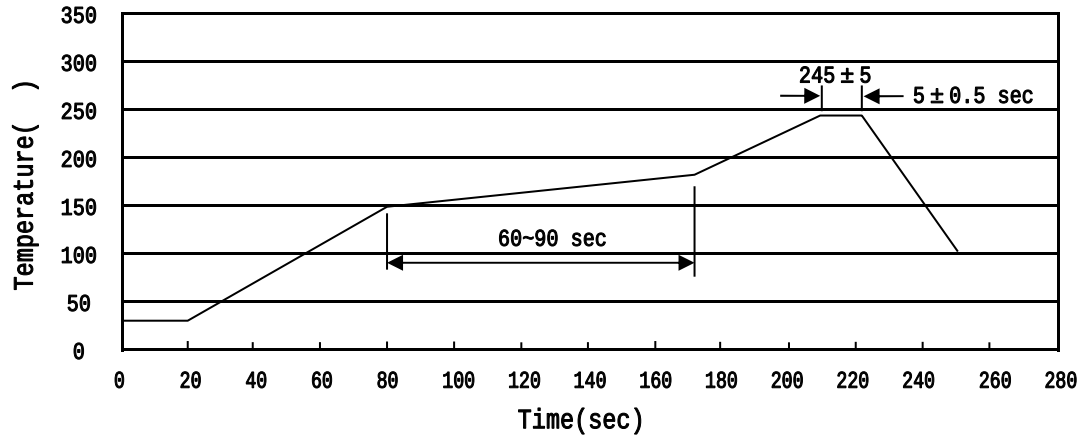
χ ᄒᄌ ᄀ ᄒ ᄁ ᄀᄇ ᄀ ᄒ ᄀ ᄒ ᄁ ᄀ Ψ ᄑ

Note:

V0543 χ Product Type Code

χ Lot No. Code, code change with Lot No

Temperature Profile for IR Reflow Soldering(Pb-Free)



ڍ ˝ χ

1 Ĺ ♬ □ ỷ 150 Ḱ 180 ł ı `H ڑ 60 Ḱ 90sec;

2 Š Ë □ ỷ 245 ° 5 ł ı `H ڑ `Y ʌ ㎛ 5 ° 0.5sec;

3 ì ˙ ϒ ˛ ↄ ♨ ỷ ㎛ 2 Ḱ 10 ł /sec.

Note:

1.Preheating:150~180 ł , Time:60~90sec.

2.Peak Temp.:245 ° 5 ł , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ł /sec.

□ ỷ χ 260 ° 5 ł `H ڑ χ 10 ° 1 sec. Temp.:260 ° 5 ł Time:10 ° 1 sec

ↄ ` ɣ Ł / REEL

Package Type	Units					Dimension		(unit mm³)
	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box
SMAF	3,000	5	15,000	6	90,000	7 ρ ×12	185×180×105	390×385×205